

OTQ-200G-SR4

200 Gb/s QSFP56 SR4 Transceiver

The OTQ-200G-SR4 200G QSFP56 SR4 transceiver is designed for Ethernet 200GBASE-SR4 applications. The module integrates four parallel lanes with baud rate at 26.5625GBd each lane. It can transmit up to 70 m on fiber OM3 fiber or 100 m on OM4 fiber with FEC. It is compliant to IEEE802.3bs, IEEE802.3cd and Common Management Interface Specification Rev4.0.

FEATURES

- Data rate up to 212.5Gbps (4x PAM4 53Gbps);
- Reach up to 70m on MMF(OM3);
- Reach up to 100m on MMF(OM4);
- 850nm VCSEL laser and PIN receiver;
- High speed I/O electrical interface (200GAUI-4);
- I2C interface with integrated Digital Diagnostic monitoring;
- Single MPO-12 receptacle;
- Single +3.3V power supply;
- Power consumption <5 W;
- Operating case temperature: 0 to +70°C;
- Compliant to RoHS-10

APPLICATION

- 200GBASE-SR4

ABSOLUTE MAXIMUM RATINGS (TC=25°C, UNLESS OTHERWISE NOTED)

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of the data sheet. Exposure to absolute maximum ratings will cause permanent damage and/or adversely affect device reliability.

Parameter	Symbol	Min	Typical	Max	Unit	Notes
Storage Temperature	TS	-40	-	+85	°C	
Maximum Supply Voltage	Vcc	-0.5	-	4.0	V	
Operating Relative Humidity	RH	15	-	+85	%	

GENERAL SPECIFICATIONS

Parameter	Symbol	Min	Typical	Max	Unit	Notes
Operating Case Temperature	Tc	0	-	70	°C	
Power Supply Voltage	Vcc	3.13	3.3	3.47	V	
Power Supply Current	Icc	-	-	1.5	A	
Maximum Power Dissipation	P _D	-	-	5	W	
Lane Baud Rate	BR _{LANE}		26.5625		GBd	
Transmission Distance	TD		-	70	m	Over MMF OM3
Transmission Distance	TD		-	100	m	Over MMF OM4

PIN DESCRIPTIONS

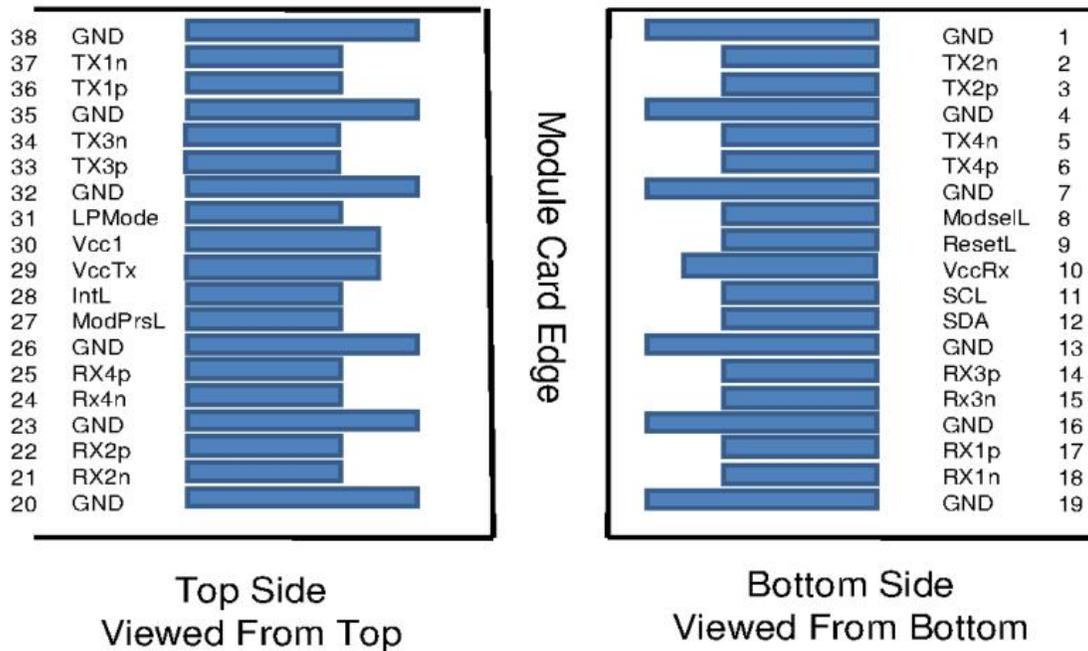


Figure 1 – Pin Definitions

PIN DESCRIPTIONS

Pin	Symbol	Name/Description	Ref.
1	GND	Ground	1
2	Tx2n	Transmitter Inverted Data Input	
3	Tx2p	Transmitter Non-Inverted Data Input	
4	GND	Ground	1
5	Tx4n	Transmitter Inverted Data Input	



Pin	Symbol	Name/Description	Ref.
6	Tx4p	Transmitter Non-Inverted Data Input	
7	GND	Ground	1
8	ModSelL	Module Select	
9	ResetL	Module Reset	
10	Vcc Rx	+3.3 V Power supply receiver	
11	SCL	2-wire serial interface clock	
12	SDA	2-wire serial interface data	
13	GND	Ground	1
14	Rx3p	Receiver Non-Inverted Data Output	
15	Rx3n	Receiver Inverted Data Output	
16	GND	Ground	1
17	Rx1p	Receiver Non-Inverted Data Output	
18	Rx1n	Receiver Inverted Data Output	
19	GND	Ground	1
20	GND	Ground	1
21	Rx2n	Receiver Inverted Data Output	
22	Rx2p	Receiver Non-Inverted Data Output	
23	GND	Ground	1
24	Rx4n	Receiver Inverted Data Output	
25	Rx4p	Receiver Non-Inverted Data Output	
26	GND	Ground	1
27	ModPrsL	Module Present	
28	IntL	Interrupt	2
29	Vcc Tx	+3.3 V Power supply transmitter	
30	Vcc1	+3.3 V Power Supply	
31	LPMODE	Low Power Mode	
32	GND	Ground	1
33	Tx3p	Transmitter Non-Inverted Data Input	
34	Tx3n	Transmitter Inverted Data Input	
35	GND	Ground	1
36	Tx1p	Transmitter Non-Inverted Data Input	
37	Tx1n	Transmitter Inverted Data Input	
38	GND	Ground	1

Notes:



[1] Circuit ground is internally isolated from chassis ground.

[2] IntL is an open collector/drain output, which should be pulled up with a 4.7k – 10k Ohms resistor on the host board. The INTL pin is deasserted "High" after completion of reset, when byte 2 bit 0 (Data Not Ready) is read with a value of '0' and the flag field is read (see SFF-8636).

ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Min	Typical	Max	Units	Notes
Receiver electrical output characteristics at TP4						
Signaling rate per lane			26.5625		GBd	
AC common-mode output voltage(RMS)			-	17.5	mV	
Differential peak-to-peak output voltage				900	mV	
Near-end ESMW (Eye symmetry mask width)			0.265		UI	
Near-end Eye height, differential		70			mV	
Far-end ESMW (Eye symmetry mask width)			0.2		UI	
Far-end Eye height, differential		30			mV	
Far-end pre-cursor ISI ratio		-4.5		2.5	%	
Differential output return loss		9.5 - 0.37f			dB	0.01 – 8 GHz
		4.75 -7.4log 10 (f/14)			dB	8 – 19 GHz
Common to differential mode conversion return loss		22-20(f/25.78)			dB	0.01 - 12.89 GHz
		15 -6log 10 (f/25.78)			dB	12.89 – 19 GHz
Differential termination mismatch				10	%	
Transition time (min, 20% to 80%)		9.5			ps	
DC common mode voltage		-350		2850	mV	
Transmitter electrical input characteristics at TP1						
Signaling rate, per lane			26.5625		GBd	
Differential pk-pk input voltage tolerance		900			mV	
Differential input return loss		9.5 - 0.37f			dB	0.01 – 8 GHz
		4.75 -7.4log 10 (f/14)			dB	8 – 19 GHz
Differential to common mode input return loss		22-20(f/25.78)			dB	0.01 - 12.89 GHz
		15 -6log 10 (f/25.78)			dB	12.89 – 19 GHz
Differential termination mismatch				10	%	
Module stressed input test		Per Section 120E.3.4.1, IEEE802.3bs				
Single-ended voltage tolerance range		-0.4		3.3	V	

Common-mode voltage		-350		2850	mV	
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LOW SPEED CONTROL AND SENSE SIGNALS

Parameter	Symbol	Min	Max	Unit	Notes/Conditions
SCL and SDA	VOL	0	0.4	V	IOL(max)=3.0 mA
	VOH	Vcc-0.5	Vcc+0.3	V	
SCL and SDA	VIL	-0.3	Vcc*0.3	V	
	VIH	Vcc*0.7	Vcc + 0.5	V	
Capacitance on SCL and SDA I/O contact.	Ci		14	pF	Looking into the module SCL and SDA contacts.
Total bus capacitive load for SCL and SDA for up to 400 kHz SCL rate (includes capacitance of all elements on the bus).	Cb		100	pF	3.0 kΩ pullup resistor
			200	pF	1.6 kΩ pullup resistor
LPMode/TxDis, ResetL and ModSell	VIL	-0.3	0.8	V	
	VIH	2	Vcc+0.3	V	
	Iin	-365	125	μA	0 V ≤ Vin ≤ Vcc
ModPrsL and IntL/RxLOSL	VOL	0	0.4	V	IOL=2.0mA
	VOH	Vcc-0.5	Vcc+0.3	V	

OPTICAL CHARACTERISTICS

Parameter	Symbol	Min	Typical	Max	Units	Notes
Transmitter						
Center Wavelength	λ_c	840	850	860	nm	
RMS Spectral width	$\Delta\lambda$			0.6	nm	
Average Launch Power, each lane		-6.5	-	4	dBm	
Optical Modulation Amplitude	OMA	-4.5	-	3	dBm	
Launch power in OMA minus TDEC		-5.9	-	-	dBm	
Average Output Power (Laser Turn off)		-	-	-30	dBm	
Side Mode Suppression Ratio	SMSR	30	-	-	dB	
Extinction Ratio	ER	3	-	-	dB	
Transmitter and dispersion eye closure	TDEC	-	-	4.5	dB	
TDECQ – 10log ₁₀ (C _{eq}), each lane				4.5	dB	
Optical Return Loss Tolerance	ORLT	-	-	12	dB	
RIN ₁₂ OMA				-128	dB/Hz	
Encircled flux at 4.5 μm				30	%	
Encircled flux at 19 μm		86			%	
Receiver						
Center Wavelength	λ_c	840	850	860	nm	

Parameter	Symbol	Min	Typical	Max	Units	Notes
Damage threshold		5	-	-	dBm	
Average receive power, each lane		-8.4		4	dBm	
Receive power, each lane (OMAouter)			-	-3	dBm	1
Receiver sensitivity (OMAouter), each lane	Rx_sen			max(-6.5, SECQ-7.9)	dBm	1
Stressed receiver sensitivity (OMAouter), each lane		-	-	-3.4	dBm	2
Reflectance	Ref	-	-	-12	dB	
LOS Assert	LOS _A	-20	-	-	dBm	
LOS De-Assert	LOS _D	-	-	-7.5	dBm	
LOS Hysteresis	LOS _H	0.5	-	5	dB	

Notes:

[1] Measured at TP3 for BER 2.4E-4 Pre-FEC

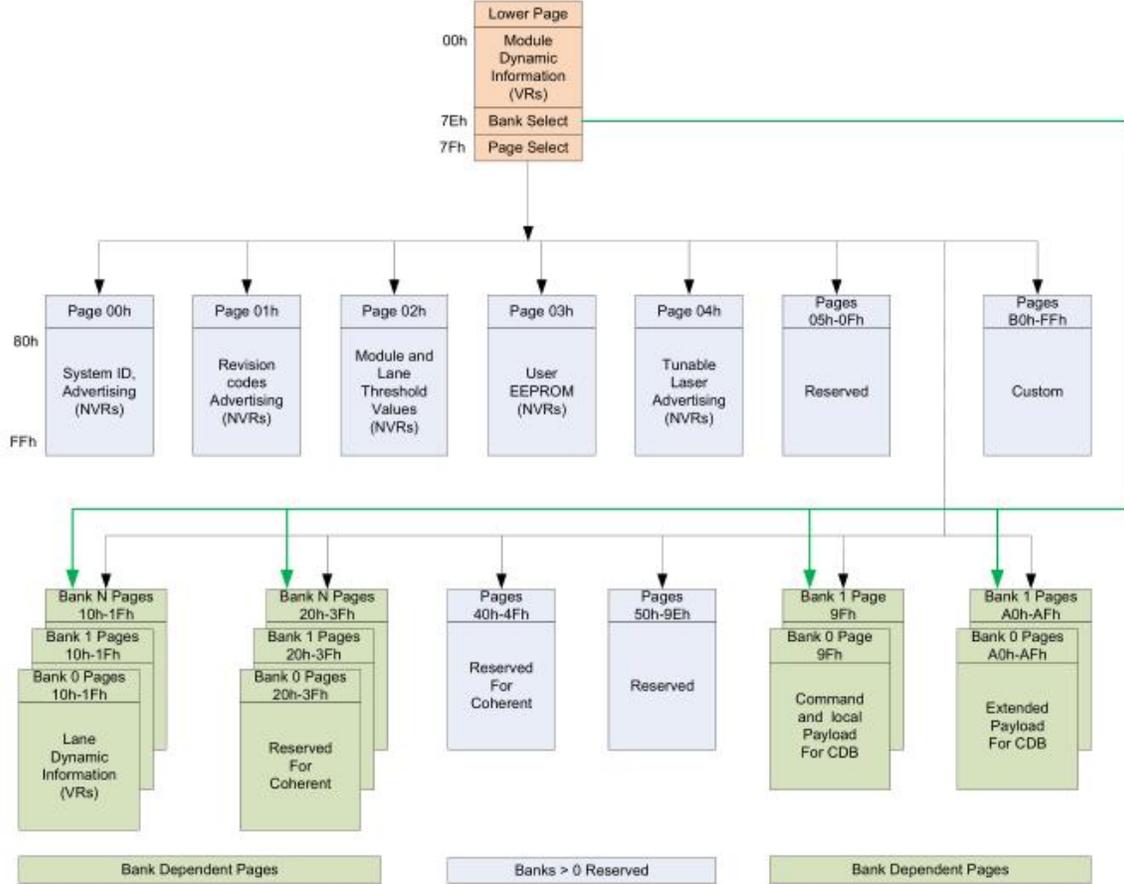
[2] Conditions of stressed receiver sensitivity test:

Stressed eye closure for PAM4 (SECQ), lane under test=4.5dB

SECQ – $10\log_{10}(C_{eq})$ (max) , lane under test =4.5dB

OMA of each aggressor lane =3dBm

Module Memory Map



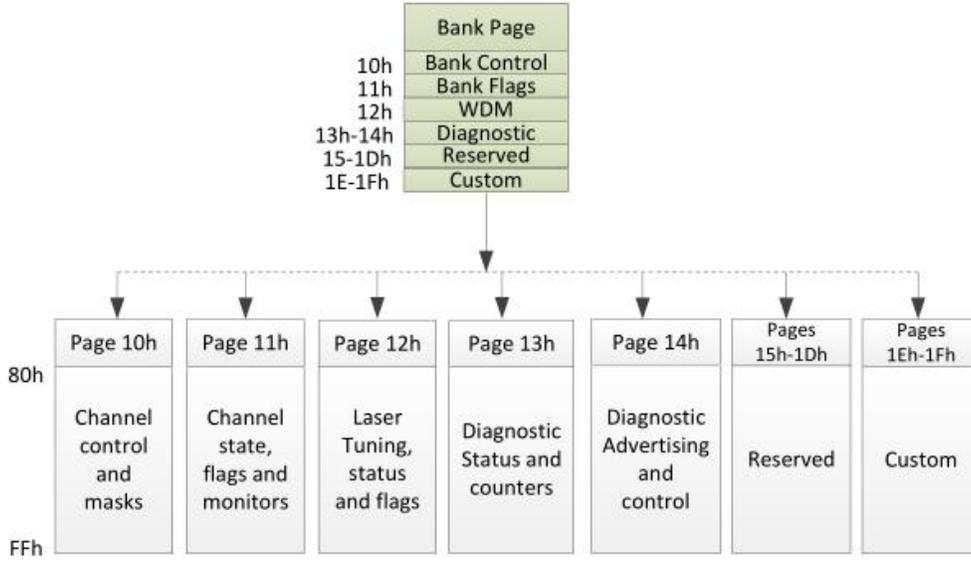


Figure 2 –Memory Map

DIGITAL DIAGNOSTIC SPECIFICATION

Parameter	Symbol	Accuracy	Units	Notes
Transceiver Case Temperature	DMI_TEMP	±3	°C	Over operating temp
Supply voltage monitor absolute error	DMI_VCC	±3%	V	Full operating range
Channel Bias current monitor	DMI_IBIAS	±3%	mA	Per channel
Channel RX power monitor absolute error	DMI_RX	±3	dB	Per channel
Channel TX power monitor absolute error	DMI_TX	±3	dB	Per channel

OPTICAL INTERFACE LANES AND ASSIGNMENT

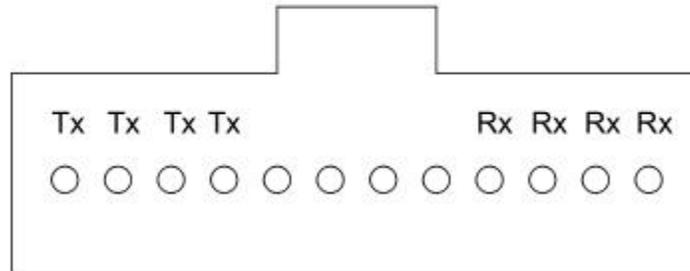


Figure 3 –Optical lanes Assignment

To minimize MPO connection induced reflections, an MPO receptacle with 8-degree angled end-face is utilized for this product.

MECHANICAL SPECIFICATIONS

unit: mm

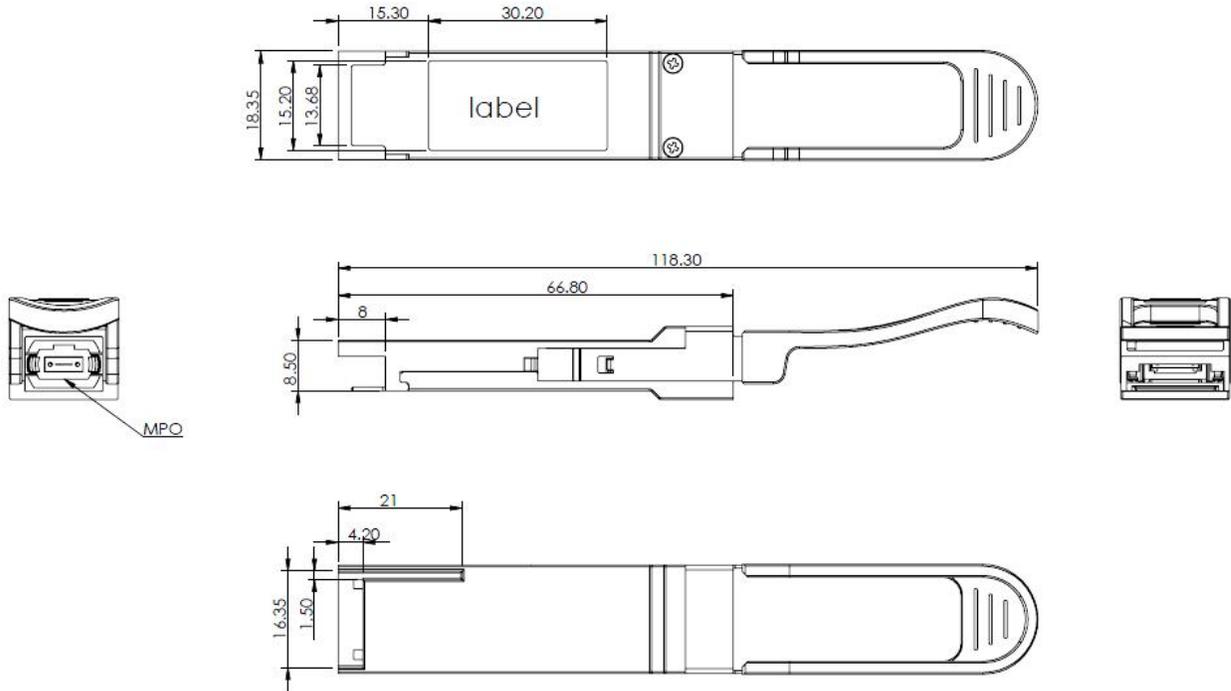


Figure 4 – QSFP56 Mechanical Specifications

ORDERING INFORMATION

OTQ-200G-SR4

ESD SAFETY CAUTIONS

This transceiver is specified as ESD threshold 1KV for high speed data pins and 2KV for all others electrical input pins, tested per MIL-STD-883, Method 3015.4 /JESD22-A114-A (HBM). However, normal ESD precautions are still required during the handling of this module. This transceiver is shipped in ESD protective packaging. It should be removed from the packaging and handled only in an ESD protected environment.